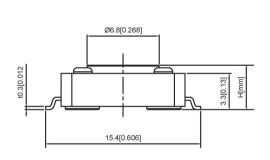


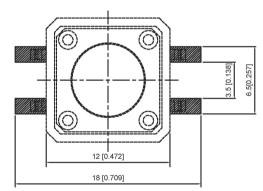
CIRCUIT DIAGRAM



Code-x	ode-x H		Code-x	Н			
Α	4.3	П	0	11.0			
В	4.5	П	P	11.5			
С	5.0	П	Q	12			
D	5.5	П	R	12.5			
Е	6.0	П	S	13.0			
F	6.5	П	Т	13.5			
G	7.0	П	U	14.0			
Н	7.5	П	٧	15.0			
I	8.0	П	W	15.5			
J	8.5	П	Х	16			
K	9.0	П	Y	17			
L	9.5	П	Z	18			
М	10.0	П	19	19			
N	10.5	П					

P.C.B MOUNTING PATTERN DIMENSION
The following soldering patterns are
recommended for reflow soldering





SPECIFICATION

Contact Rating: 50mA,12V DCContact Resistance: $100\text{m}\Omega$ max
Insulation Resistance: $100\text{m}\Omega$ min.500V DC
Dielectric Strength: 250V AC/1minute
Operating Towns

2007 1957

 Travel:
 0.25mm

 Operating Temp:
 -30 °C ~+85 °C

 Storage Temp:
 -30 °C ~+80 °C

PAPT NO	TS-1103S-X-X					
Operating Force	B:160gf C:260gf					
Height	Code-x					

(5)	Terminal	_	4	Brass (0.30t)	Plating silvering	
4	Contact	_	1	F.ag/Sus	Natural	
3	Base		1	Pa46		
0	Cover	_	1	Spcc	Plating Nickel	
0	Keystake	<u> </u>	1	Pa46		
ITEM	PAPT NAMF	TER,NO	QTY	MATERIAL	FINISHING	REMARK

	١.	6 9 11 4 11 m 1 4 m 1 7								eystake — PT NAMF TER,NO Q	Pa46 TY MATERIAL	FINISHING	REMARK	
■厂压星坤科技股份有限公司							1					N/A MODEL	TYPE:	
	\vdash							DSND		DATE	SCALE	. 19//	TACT :	SWITCH
	业					units: tolerance:	mm	DWN		DATE	VIEW:	PART	IO.:	
		<u>Λ</u> Χ					±0.2mm	CHKD		DATE	UNIT: m			
	双	AX DESCRIPTION					±0.1mm					DWG N		
		MARIZ DECORP TION	DATE	REVISED	APPROVED	X.XXX	±0.05mm	APPD		DATE	SIZE: A	\4	TS-11035	
	REV SIONS UNSPECIFIED T						OLERANCES	XKB INDUSTRIAL PRECISION CO.,LIMITED WEIGHT SHEE				T SHEET	REVISION A0	
	-	AT WWW.	IEIIOXKD.COITI WWW.HEIIOXKD.CIT								•	1.09		I AU